	Туре	L #	Hits	Search Text	DBs	Time Stamp	Comment s
1	BRS	L1	201	satoshi near fujimoto.in.	USPA T; US-P GPUB; EPO; DERW ENT; IBM TDB	2004/01/1 7 14:23	
2	BRS	L2	2	1 and (gate near electrode)	USPA T; US-P GPUB; EPO; JPO; DERW ENT; IBM_ TDB	2004/01/1 7 14:23	
3	BRS	L3	141	tsunoda near akira.in.	USPA T; US-P GPUB; EPO; JPO; DERW ENT; IBM_ TDB	2004/01/1 7 14:29	
4	BRS	L4	903	438/149.ccls.	USPA T; US-P GPUB; EPO; JPO; DERW ENT; IBM_ TDB	2004/01/1 7 17:00	

	Туре	L #	Hits	Search Text	DBs	Time Stamp	Comment
5	BRS	L5	1886	(gate near electrode) near15 (second near conductive)	USPA T; US-P GPUB; EPO; JPO; DERW ENT; IBM_ TDB	2004/01/1 7 16:16	
6	BRS	L6	391	(gate near electrode) near15 (second near conductive near layer) near10 (first near conductive near layer)	USPA T; US-P GPUB; EPO; JPO; DERW ENT; IBM_ TDB	2004/01/1 7 16:17	
7	BRS	L8	7	(gate near electrode) near15 (second near conductive near layer) near10 (first near conductive near layer) near15 (semiconductor near device) near15 (thin ot tft)	USPA T; US-P GPUB; PO; JPO; DERW ENT; IBM_ TDB	2004/01/1 7 16:18	
8	BRS	L 7	53	(gate near electrode) near15 (second near conductive near layer) near10 (first near conductive near layer) near15 (semiconductor near device)	USPA T; US-P GPUB; PO; DERW ENT; IBM_ TDB	2004/01/1 7 16:20	

	Туре	L #	Hits	Search Text	DBs	Time Stamp	Comment s
9	BRS	L9	137	(impurity near region) near10 (concentration near distribution)	USPA T; US-P GPUB; EPO; JPO; DERW ENT; IBM_ TDB	2004/01/1 7 17:02	
10	BRS .	L10	4	(impurity near region) near10 (concentration near distribution) near15 (increas\$2 near5 distance)	USPA T; US-P GPUB; EPO; JPO; DERW ENT; IBM_ TDB	2004/01/1 7 17:04	
11	BRS	L11	14	(impurity) near10 (concentration near distribution) near15 (increas\$2 near5 distance)	USPA T; US-P GPUB; EPO; JPO; DERW ENT; IBM_ TDB	2004/01/1 7 17:04	
12	BRS	L12	14	(impurity) near10 (concentration near distribution) near15 (increas\$2 near3 distance)	USPA T; US-P GPUB; PO; JPO; DERW ENT; IBM_ TDB	2004/01/1 7 17:07	

	Туре	L #	Hits	Search Text	DBs	Time Stamp	Comment
13	BRS	L13	9	(impurity) near10 (concentration near distribution) near15 (distance) near15 (channel)	USPA T; US-P GPUB; EPO; JPO; DERW ENT; IBM TDB	2004/01/1 7 17:19	
14	BRS	L14	O	(concentration near distribution) near15 (exponetial near distribution)	USPA T; US-P GPUB; EPO; JPO; DERW ENT; IBM_ TDB	2004/01/1 7 17:21	
15	BRS	L15	O .	(concentration near distribution) near15 (exponetial)	USPA T; US-P GPUB; EPO; JPO; DERW ENT; IBM_ TDB	2004/01/1 7 17:21	
16	BRS	L16	0	(concentration) near15 (exponetial)	USPA T; US-P GPUB; PO; DERW ENT; IBM_ TDB	2004/01/1 7 17:21	·

	Туре	L	#	Hits	Search Text	DBs	Time Stamp	Comment
17	BRS	L1	7	1265	(concentration) near15 (exponential)	USPA T; US-P GPUB; EPO; JPO; DERW ENT; IBM_ TDB	2004/01/1 7 17:21	
18	BRS	L1	8	15	(concentration near distribution) near15 (exponential)	USPA T; US-P GPUB; EPO; JPO; DERW ENT; IBM_ TDB	2004/01/1 7 17:21	
19	BRS	L2	0	0	(concentration near distribution) near15 (exponential near distribution) near15 (semiconductor)	USPA T; US-P GPUB; EPO; JPO; DERW ENT; IBM_ TDB	2004/01/1 7 17:22	
20	BRS	L 1	9	10	(concentration near distribution) near15 (exponential near distribution)	USPA T; US-P GPUB ; EPO; JPO; DERW ENT; IBM TDB	2004/01/1 7 17:22	

	U	1	PT	P	Document ID	Issue Date	Pages	Title
1	⊠.				US 20030096460 A1	20030522	43	Method of manufacturing semiconductor devices
2	⊠ _.				US 20030094614 A1	20030522	29	Semiconductor device and method of manufacturing the same
3	×				US 20020110941 A1	20020815	36	Semiconductor device and manufacturing method thereof
4	×				US 20020089616 A1	20020711	15	Thin film semiconductor device and liquid crystal display unit, and fabrication methods thereof
5					US 6587165 B2	20030701	15	Thin film semiconductor device and liquid crystal display unit, and fabrication methods thereof
6					US 6518594 B1	20030211	43	Semiconductor devices
7	×				US 6501098 B2	20021231	56	Semiconductor device